

Conference Program

2018 the International Conference on Product and Industrial Engineering

2018 年产品与工业工程国际会议 ICPIE 2018

2018 the International Conference on Civil Engineering and Architecture

2018 年土木工程与结构国际会议 ICCEA 2018

October 27-29, 2018

Chengdu, China

Venue: Chengdu Tibet Hotel

成都西藏饭店

Address: No. 10, First Session, Renmin Road North, Chengdu

中国·成都·人民北路一段 10 号

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Welcome Letter

Dear Participants,

Welcome to 2018 the International Conference on Product and Industrial Engineering (ICPIE 2018) together with 2018 the International Conference on Civil Engineering and Architecture (ICCEA 2018)! The objective of these two conferences is to provide a premium platform to bring together scientists, researchers, engineers, academics and graduate students in the fields of product & industrial engineering and civil engineering to share up-to-date research results. We convince that during the conference, you will get the theoretical grounding, practical knowledge, as well as personal contacts that will help you to build long-term, profitable and sustainable communication among researchers and practitioners in the relevant scientific domains.

We wish to take this opportunity to express my heartfelt appreciation to Prof. C. W. Lim from City University of Hong Kong, Prof. Cees de Bont from Loughborough University, Prof. Thomas Kang from Seoul National University, Prof. Kyung-Jae Shin from Kyungpook National University. We also want to express our thanks to the reviewers for their excellent works to ensure the academic quality and scholarship. Without your efforts, the conference will not be possible to be held.

Finally, I would like to thank the conference speakers and all attendees for coming to Chengdu to share their knowledge with the rest of the participants. I hope that these speeches will be proved to be intellectually stimulating to all participants.

Hope you will enjoy the conference, the food, the hospitality, and the beautiful and charming environment of Chengdu!

Conference Organizing Committees

Instructions for Presentation

Registration Guide:

Arrive at the Conference Venue→Inform the conference staff of your paper ID→Sign your name on the Participants List→Check your conference materials.

Checklist:

1 receipt, 1 name card, 1 printed conference abstract, 1 lunch coupon, 1 dinner coupon, 1 computer bag, 1 USB stick (paper collection).

Devices Provided by the Conference Organizer:

Laptops (with MS-Office & Adobe Reader)

Projectors & Screen

Laser Sticks

Materials Provided by the Presenters:

PowerPoint or PDF files

Duration of each Presentation:

Regular Oral Session: 15 Minutes of Presentation including 2-3 Minutes of Q&A

Notice:

*Certificate of Listener can be collected in the registration counter.

*Certificate of Presentation can be collected from the session chair after each session.

*The organizer will not provide accommodation, so we suggest you make an early reservation.

*One best presentation will be selected from each session. The best one will be announced when each session ends and will be awarded by the session chair after each session in the meeting room.

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Agenda Overview

Saturday, October 27, 2018		
10:00-17:00	Conference Check in and Materials Collection	Lobby 酒店大堂
Sunday, October 28, 2018		
Opening Ceremony		
9:00-9:05	Prof. C. W. Lim City University of Hong Kong, Hong Kong	Hongshan 红山厅
Keynote & Plenary Speeches		
9:05-9:45	<p>Speech I</p> <p>Prof. Cees de Bont, Loughborough University, UK</p> <p><i>Speech Title: Design as the Interplay between Prototyping, Human Factors, Design Experience and Safety</i></p>	Hongshan 红山厅
9:45-10:25	<p>Speech II</p> <p>Prof. C. W. Lim, City University of Hong Kong, Hong Kong</p> <p><i>With co-author</i></p> <p>Assoc. Prof. Mei-yung Leung, City University of Hong Kong, Hong Kong</p> <p><i>Speech Title: Value Management for Complex Projects</i></p>	
10:25-10:45	Coffee Break & Group Photo	Foyer 会议室 门厅
10:45-11:25	<p>Speech III</p> <p>Prof. Thomas Kang, Seoul National University, South Korea</p> <p><i>Speech Title: Education, Research & Practical Innovation of IoT Technology in Building Construction</i></p>	Hongshan 红山厅

11:25-12:05	<p style="text-align: center;">Speech IV Prof. Kyung-Jae Shin Kyungpook National University, South Korea <i>Speech Title: Application of IT technology to Structural Engineering</i></p>	
12:05-13:30	Lunch	2F- Auspicious Ball Room 2楼藏宴厅
Oral Presentation Sessions		
13:30-15:45	<p>Session 1: Performance Analysis of Concrete and Building Materials Session chair: Assoc. Prof. Hyeon-Jong Hwang, Hunan University, China</p>	Hongshan 红山厅
15:45-16:00	Coffee Break	Foyer 会议室 门厅
16:00-18:30	<p style="text-align: center;">Session 2: Urban Infrastructure Construction and Service Session chair: Dr. Jue Wang, Hohai University, China</p>	Hongshan 红山厅
16:00-18:30	Poster Session	Hongshan 红山厅
18:30-20:00	Dinner	2F- Yak Cafe 2楼亚克 咖啡厅
Monday, October 29, 2018		
One Day Tour in Chengdu		
<p>Attractions: Giant Panda Research Base, Wenshu Monastery, Kuanzhai Xiangzi Alleys and Tea-tasting in People's Park (Lunch and Tickets of Scenic Spots are already included in the fee)</p>		